



Product/Process Change Notifications

PCN - 17 061

Release Date: August 16 2017

Product Name:	DDR4 ULP TH		
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Product Manager:	Bonnie Liu		
Subject:	Notification of Planned Change		
Distribution:	Global		
Type of Change:	Materials Change		
Change Description:	Introduction of new Resin material for DDR4 ULP housing/latch to BOM Before chage: Resin material in BOM is " PA4T" After change: Resin material in BOM is "PA4T or HFX 61S"		
Reason for Change:	New resin material introduced as alternate BOM to reduce material purchasing lead time and MOQ constraint.		
Affected Parts:	See attached Affected Parts list		
Effective Date of Change:	February 16,2018		
Last Time Buy Date:	NA		
Last Disty Return Date:	NA		
Last Time Shipment Date	NA		
Datasheet Attached?	NA		
Qual/Test Data Attached?	NA		
Samples Availability Date:	July	20	2017
Available Alternatives?	N/A		
Questions?	<i>Contact your local AICC/AFCI Representative, or Product Manager</i>		
	<i>Bonnie Liu / Product Manager</i>		
	<i>+86 769 88669459/ Bonnie.liu@fci.com</i>		

Note:

Customer shall intimate the product Manager any Concern regarding the PCN within 3 weeks of the release date.
PCN is considered approved by the customer if no communication is received within 3 weeks

PCN Reference	MPN	Change	Effective Date
PCN17061	10129206-0010011LF	MATERIAL CHANGE	16-Feb-18
PCN17061	10129206-0010013LF	MATERIAL CHANGE	16-Feb-18
PCN17061	10129206-0011013LF	MATERIAL CHANGE	16-Feb-18
PCN17061	10129206-0011101LF	MATERIAL CHANGE	16-Feb-18
PCN17061	10129206-0011111LF	MATERIAL CHANGE	16-Feb-18
PCN17061	10129206-0011113LF	MATERIAL CHANGE	16-Feb-18
PCN17061	10129206-0012013LF	MATERIAL CHANGE	16-Feb-18
PCN17061	10129206-0012201LF	MATERIAL CHANGE	16-Feb-18
PCN17061	10129206-1001001LF	MATERIAL CHANGE	16-Feb-18
PCN17061	10129206-1001013LF	MATERIAL CHANGE	16-Feb-18
PCN17061	10129206-1002013LF	MATERIAL CHANGE	16-Feb-18